



2Q/1H FY26 Results Briefing

24 August 2026



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Optimising opportunities and eXtending Boundaries



Penang Science Park ("PSP") Factory 2 Phase 1



Based in Penang



Founded in 2002

***An integrated engineering solutions provider,
specialising in:***

- **Precision Engineering Components Solutions**

Fabricate sheet metal and CNC-machined components, as well as plastic injection moulded products.

- **Mechanical Assembly Solutions**

Design and manufacture assembled products, including structures, equipment and machineries in semi-assembled or fully assembled forms.

- **Automation and Robotics Solutions**

Design and manufacture of standalone automated equipment, production line systems, and provision of smart factory systems solutions.

Stock Code	OXB/0368
Share Price	RM0.49 (as of 21 Aug 2026)
Listing Bourse	ACE Market
Listing Date	29 Jul 2025
Shariah Status	Shariah-Compliant
Market Cap.	RM347.9 mil
Shares Outstanding	710.0m

Growth Roadmap At A Glance



CG Solutions (est. 2002)
CG Manufacturing (est. 2011)
Creative Gravity (est. 2012)

2002 - 2022

Founded to supply industrial products, expanded into metal fabrication, precision engineering, assembled parts, automation and robotics solutions.



2023 - 2024



2025 - 2026



2027



EDM Holdings (est. 2002)

2002 - 2022

Involved in manufacturing of turning products and robotics solutions. Secured a warehouse robotics contract from a U.S.-based memory and storage products company.



1995 - 2022



Oxford Bond (est. 1995)

Started as a precision metal products manufacturer and expanded into a supplier of ergonomic furniture components, supported by a broad customer base that drives growth.



**Optimizing Opportunities,
eXtending Boundaries**

Three companies merged in 2023 to form Oxford Innotech Berhad.

The merger was synergistic, **creating a one-stop solution** for customers and **significantly expands OXB's customer base** across consumer, automotive, E&E, and semiconductor segments.

In 2024 – OXB **secured substantial supply contracts from SIBS**, a European-based, manufacturing-inspired modular building system provider.

Building Momentum

In 2025 – **Strengthening our presence in the semiconductor industry:** The growing number of approved components and positive progress in mass production leads to a steady ramp-up in deliveries.

In 2026 – **Successfully penetrated the data centre segment:** Recent contract wins of RM9.6m is a good start. We are pursuing more opportunities in this segment.

Together, these focus areas underpin a positive growth trajectory and reinforce our confidence moving forward.

Next Phase of Growth

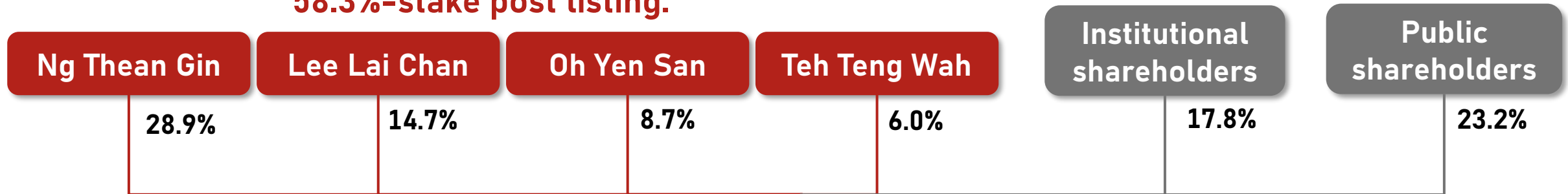
Data Centre
Positive on the future opportunities. Existing customer is expected to build three new, larger-scale data centres in 2027. OXB is well positioned to tap into this development, supported by our proven track record.

Semiconductor
Customers J2 and P2 are expected to drive further mass production orders, following increased in approved components in 2025 and 2026.

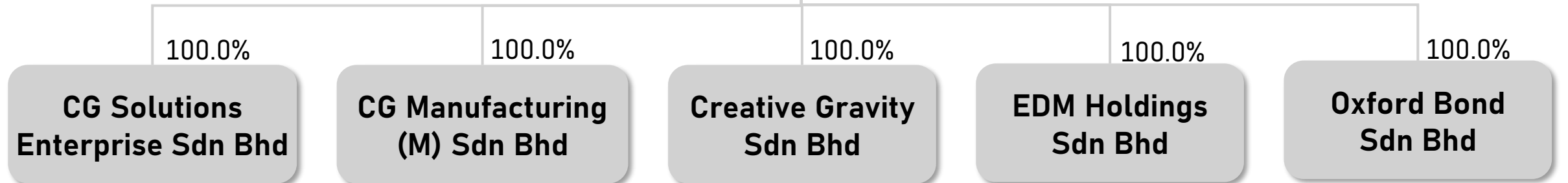
MBS
Sustained order pipeline commencing end-2026 & early-2027 is expected to support demand for precision steel components.

Shareholding & Corporate Structure as at 31 Jul 2026

Promoters and major shareholders continue to hold a
58.3%-stake post listing.



*Increased from
9.6% @ July 2025*



Financials – Results Review



2QFY26 PAT More Than Doubled YoY

RM'm (FYE Dec)	2QFY26	2QFY25 YoY	1QFY26 QoQ	YoY chg	QoQ chg
Revenue	24.5	17.1	17.8	+43.7%	+37.7%
GP	7.8	4.9	6.5	+57.4%	+19.4%
PAT	4.2	1.6	3.3	+162.5%	+27.7%
Adj. PAT*	4.2	2.0	3.3	+105.8%	+27.7%
GP Margin	31.7%	28.9%	36.5%	+2.8 ppt	-4.8 ppt
PAT Margin	16.9%	9.3%	18.2%	+7.6 ppt	-1.3 ppt
Adj. PAT Margin*	16.9%	11.8%	18.2%	+5.1 ppt	-1.3 ppt

2QFY26 vs 2QFY25 (YoY)

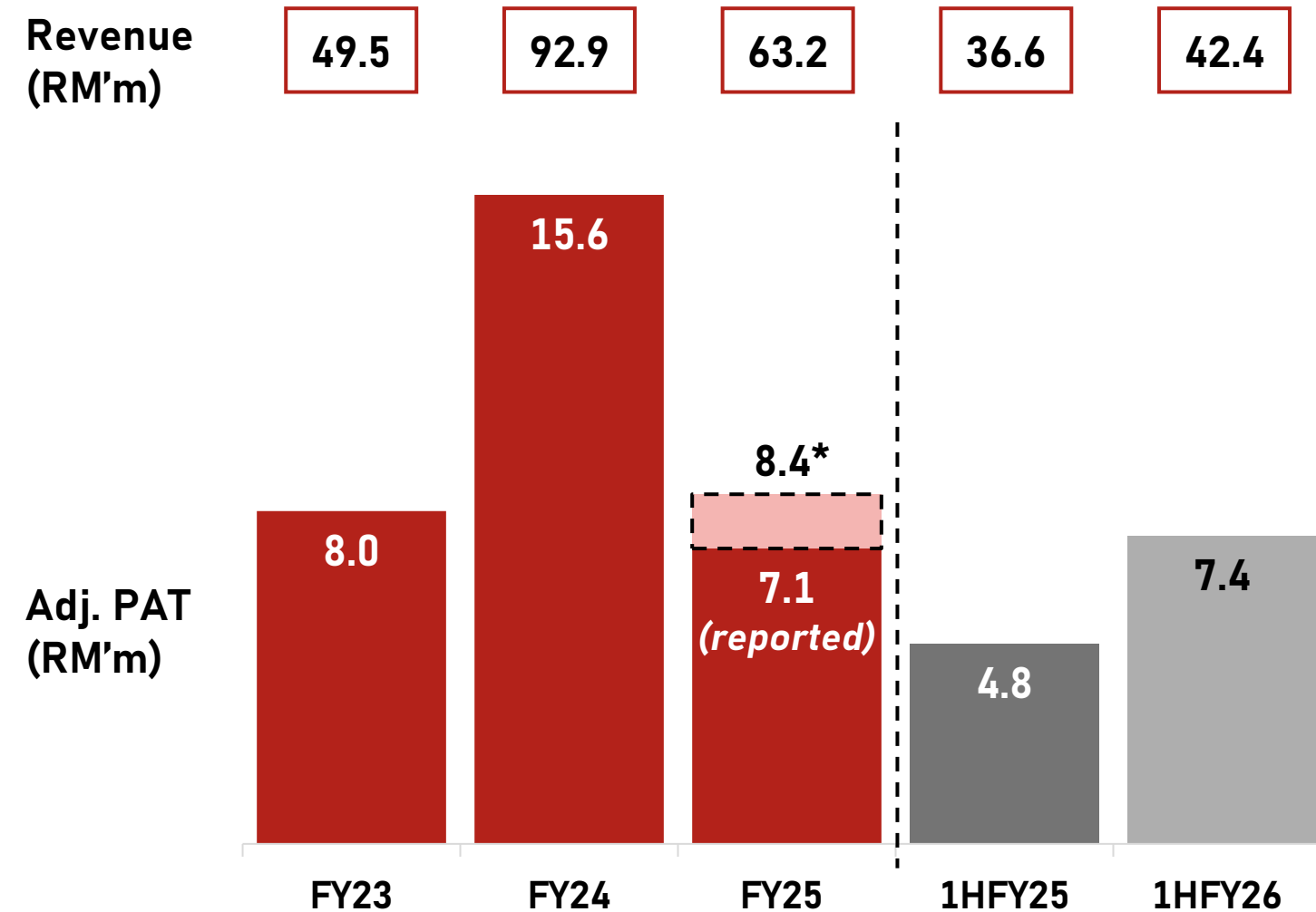
- Improved revenue was attributable mainly to contributions from customers operating in the **data centre ("DC")**, **semiconductor and electrical & electronics ("E&E")** industries.

2QFY26 vs 1QFY26 (QoQ)

- Higher revenue mainly due to **deliveries to customers in semiconductor and data centre segments**.
- Slightly offset by increase in operating costs, primarily due to foreign worker recruitment costs, overtime expenses and additional headcount required.

*PAT adjusted for RM0.4m listing expenses in 2QFY25. Adjusted profit margins reflect core operating performance.

1HFY26 PAT Reached 88% of FY25 Core PAT



1HFY26 PAT of RM7.4 million already reached 88.6% of FY25 core PAT of RM8.4 million.

Strong 1HFY26 performance supported by growing orders from customers in the DC, semiconductor and E&E industries.

*Adjusted PAT after adding back listing expenses of RM1.3 million in FY25.

Solid Balance Sheet Position

RM'm (FYE Dec)	FY25 (audited)	2QFY26 (unaudited)	
TOTAL ASSETS	168.0	172.1	
Cash and cash equivalents	54.6	46.6	
TOTAL LIABILITIES	40.7	41.0	• Pared down borrowings, offset by an increase in trade and other payables.
Total borrowings^	24.8	22.2	
TOTAL EQUITY	127.3	131.2	
Current ratio (times)	7.3	6.1	• Liquidity remains strong with healthy current ratio and net cash position.
Gearing ratio (times)	0.2	0.2	
Net operating cash flow	20.4	3.0	• Healthy positive net operating cash flow

^Total borrowings comprise bank borrowings and lease liabilities owing to financial institutions (and exclude tenancy-related lease liabilities).

IPO Proceeds to Drive Next Phase of Growth

Strengthening our capacities and capabilities to undertake more projects

Purpose	Proposed Utilisation		Actual Utilisation	Balance to be Utilised
Utilisation of proceeds @ 21 August 2026	RM'm	%	RM'm	RM'm
Construction of a new factory	23.1	55.5	-	23.1
Purchase/refinancing of new machinery	11.2	26.9	3.9	7.3
General working capital	3.3	8.0	3.0	0.3
Estimated listing expenses	4.0	9.6	4.0	-
Total	41.6	100.0	10.9	30.7

Business Updates & Outlook



Qualification Efforts Starting To Bear Fruits

Jun-Jul 2026

OXB has secured 3 purchase orders (“POs”) totalling **RM8.8m**, to supply precision engineering components for mass flow controllers for the semiconductor industry.

2Q 2025 – May 2026

Jun 2026

Jul 2026

Focused on First Article approvals



Secured two POs:
RM3.2m



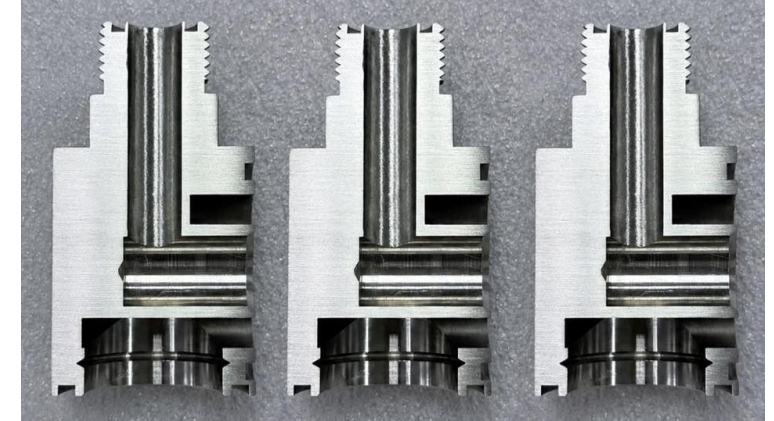
Received 3rd PO:
RM5.6m

Customer P2

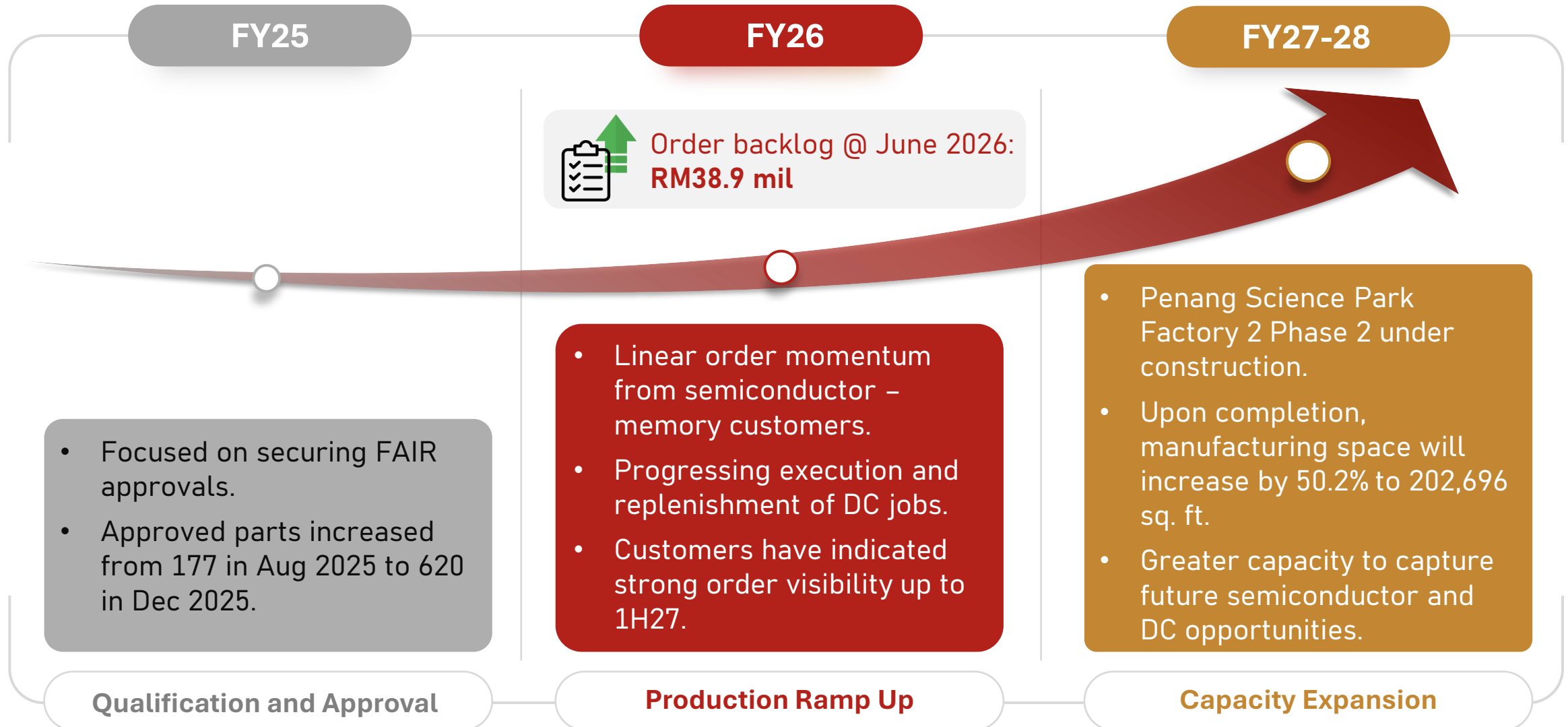
Leading US-based company specialising in mass flow controllers, with a manufacturing facility in Malaysia. It serves global customers across industries including,

- semiconductor
- renewable energy
- optical solutions
- aerospace

Parts we supplying for Customer P2:



Semiconductor Segment Enters Execution Phase



Revenue Contribution by Top 5 Customers

Growth driven by diverse base of customers: J2, G, P2, M2, C2, H, and SIBS.

										Expected top 5 contributor:	
Sector	Customers	2022		2023		2024		2025		2026	2027
		RM 'm	%	RM 'm	%	RM 'm	%	RM 'm	%	Ranking	Ranking
Semiconductor (Memory/ Equipment/ others)	EDM Holdings	4.4	15.2								
	Customer A	2.3	7.9								
	Customer B	3.5	12.1								
	Customer F	2.6	9.0								
	Customer J2							6.0	9.5	#2	#2
	Customer G			6.9	13.9	10.4	11.2	5.9	9.3	#3	#5
	Customer P2									#5	#3 or #4
	Customer M2										#3 or #4
Data Centre	Customer C2									#1	#1
MBS	SIBS			6.2	12.4	39.3	42.3	9.6	15.2		#5
	Klitz Vibrant					3.0	3.2				
E&E	Customer E	2.3	8.1			2.0	2.1				
	Amphenol TCS							3.1	4.9		
Consumer	Customer H			4.0	8.1	11.8	12.7	6.9	11.0	#4	
Robotics	Siasun Group			2.4	4.9						
Automotive	Customer I			2.2	4.4						
Total		15.1	52.3	21.7	43.7	66.5	71.5	31.5	49.9	-	-

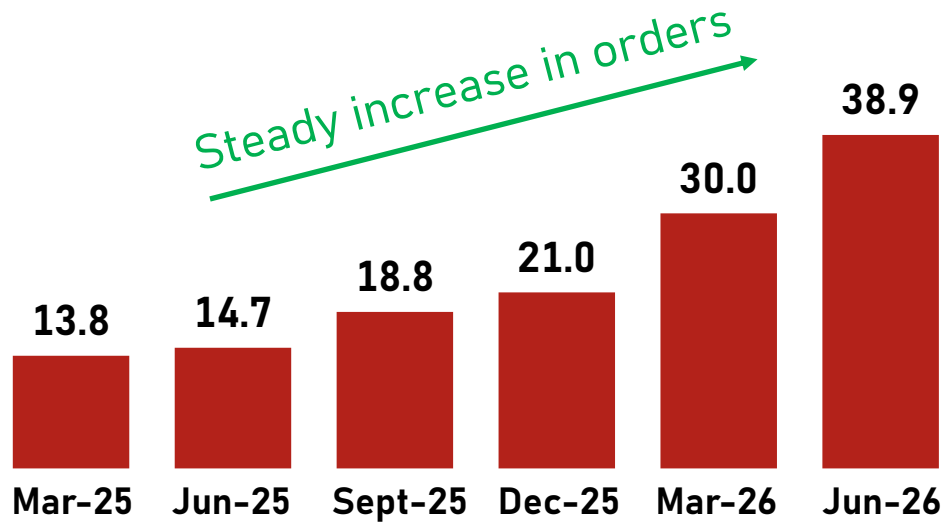
Sector Exposure

	2024 (actual)	2025 (actual)	2026 (estimated)
Semiconductor	24.5%	48.1%	~57%
Data Centre	0.0%	0.0%	~24%
E&E	18.4%	17.2%	~10%
MBS	45.5%	16.6%	~3-5%
Others	11.5%	18.0%	~3-7%
Total	100%	100%	100%

- Qualification efforts in FY25 have translated into mass production in FY26, with growing contributions from semiconductor customers.
- Memory segment accounted for about half of the semiconductor industry revenue.

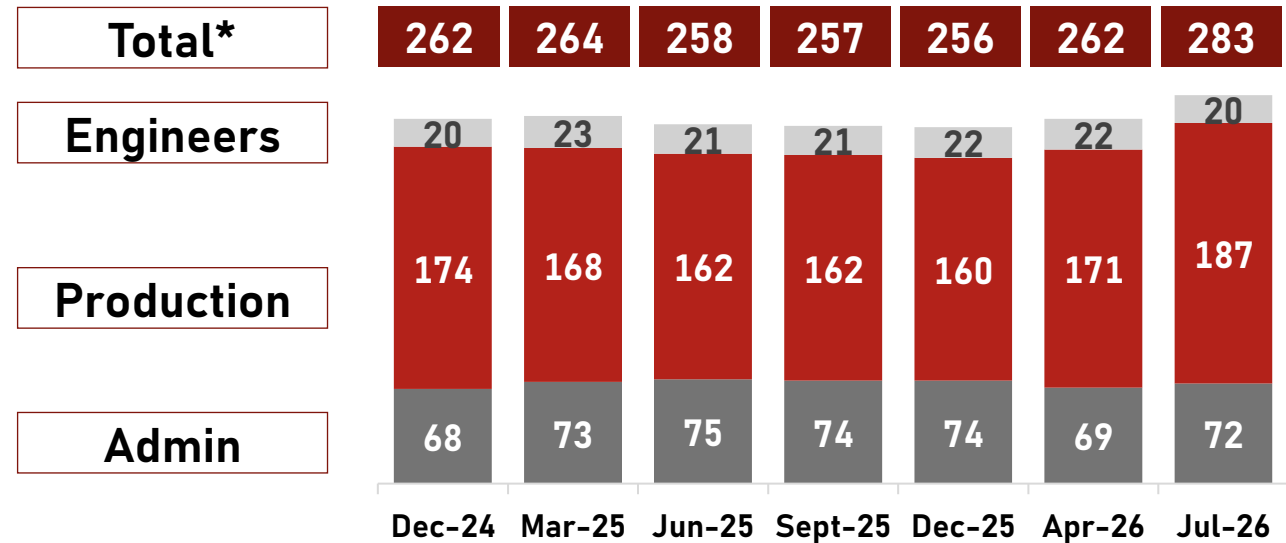
Other Key Developments

Order backlog (RM'm)



Rising order backlog driven by **mass production orders following first article approvals** and **DC orders**.

Our staff force as of July 2026



Increased production headcount to support strong customer orders.

**Approximately 34% of total workforce are foreign workers.*

Capacity Expansion Plans – PSP Factory 2 (Phase 2)



Construction began in June 2026, with completion slated for second half of 2027.

Existing
Manufacturing Areas

135k sq. ft.



PSP Factory 2 (Phase 2)
Manufacturing Area

68k sq. ft.



203k
sq. ft.



50 %

Increase in capacity upon
commencement of operations

PSP Factory 2 (Phase 2) artist impression:





THANK YOU

For queries, please contact Evon at
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